

RCJ160N20 Nch 200V 16A Power MOSFET

V _{DSS}	200V
R _{DS(on)} (Max.)	180mΩ
I _D	±16A
P _D	85W

Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant
- 6) 100% Avalanche tested

Application

Switching Power Supply

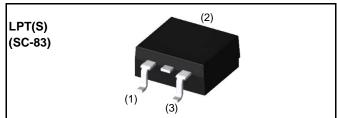
Automotive Motor Drive

Automotive Solenoid Drive

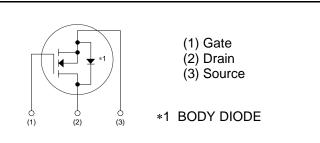
●Absolute maximum ratings(T_a = 25°C)

Paramete	Symbol	Value	Unit	
Drain - Source voltage	V _{DSS}	200	V	
Continuous drain surrant	$T_c = 25^{\circ}C$	I _D ^{*1}	±16	А
Continuous drain current	$T_c = 100^{\circ}C$	I _D ^{*1}	±8.7	A
Pulsed drain current		I _{D,pulse} *2	±64	А
Gate - Source voltage		V _{GSS}	±30	V
Avalanche energy, single puls	e	E _{AS} *3	20.7	mJ
Avalanche current		I _{AR} *3	8.0	А
$T_c = 25^{\circ}C$		P _D	85	W
Power dissipation $T_a = 25^{\circ}C^{*4}$		P _D	1.56	W
Junction temperature		Tj	150	°C
Range of storage temperature		T _{stg}	-55 to +150	°C

Outline



Inner circuit



Packaging specifications

	Packaging	Taping
	Reel size (mm)	330
Type	Tape width (mm)	24
Туре	Basic ordering unit (pcs)	1,000
	Taping code	TL
	Marking	RCJ160N20

•Thermal resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	1.46	°C/W
Thermal resistance, junction - ambient *4	R_{thJA}	-	-	80	°C/W
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C

•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions		Values		Unit	
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	200	-	-	V	
		$V_{DS} = 200V, V_{GS} = 0V$			10		
Zara gata valtaga drain aurrant		T _j = 25°C	-	-	10	μA	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 200V, V_{GS} = 0V$		-	100		
		T _j = 125°C	-				
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 30 V, V_{DS} = 0 V$	-	-	±100	nA	
Gate threshold voltage	V _{GS (th)}	$V_{DS} = 10V, I_D = 1mA$	3.25	-	5.25	V	
		$V_{GS} = 10V, I_{D} = 8.0A$	-	135	180		
Static drain - source on - state resistance	$R_{DS(on)}$ *5	$V_{GS} = 10V, I_D = 8.0A$		205	410	mΩ	
		T _j = 125°C	-	295	410		
Forward transfer admittance	9 _{fs}	$V_{DS} = 10V, I_{D} = 8.0A$	4	8	-	S	

●Electrical characteristics(T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	1370	-	
Output capacitance	C _{oss}	V _{DS} = 25V	-	95	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	50	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 100V, V_{GS} = 10V$	-	27	-	
Rise time	t _r *5	I _D = 8.0A	-	47	-	20
Turn - off delay time	t _{d(off)} *5	R _L = 12.5Ω	-	42	-	ns
Fall time	t _f *5	$R_G = 10\Omega$	-	17	-	

•Gate Charge characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Symbol Conditions -		Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	$V_{DD} \simeq 100V$	-	26	-	
Gate - Source charge	Q_{gs} *5	I _D = 16A	-	10	-	nC
Gate - Drain charge	Q_{gd} *5	V _{GS} = 10V	-	11	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 100V, I_D = 16A$	-	7.0	-	V

●Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Onit
Continuous source current	ا _S *1	-Т _с = 25°С	-	-	16	А
Pulsed source current	I_{SM} *2	1 _c = 25 C	-	-	64	А
Forward voltage	V_{SD} *5	$V_{GS} = 0V, I_{S} = 16A$	-	-	1.5	V
Reverse recovery time	t _{rr} *5	I _S = 8.0A	-	85	-	ns
Reverse recovery charge	Q _{rr} ^{*5}	di/dt = 100A/µs	-	300	-	nC

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10 $\mu s,$ Duty cycle \leq 1%

*3 L \simeq 500 μ H, V_{DD} = 50V, Rg = 25 Ω , starting T_j = 25°C

*4 Mounted on a epoxy PCB FR4 (25mm × 27mm × 0.8mm)

*5 Pulsed

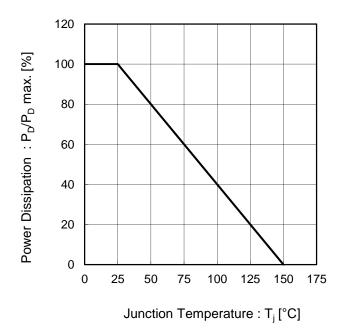
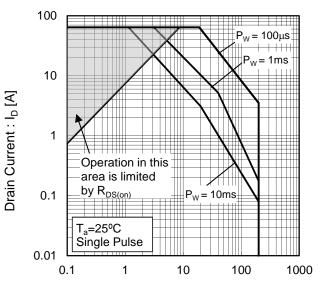


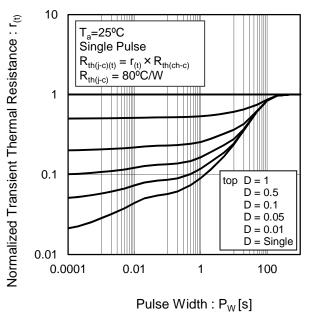
Fig.1 Power Dissipation Derating Curve

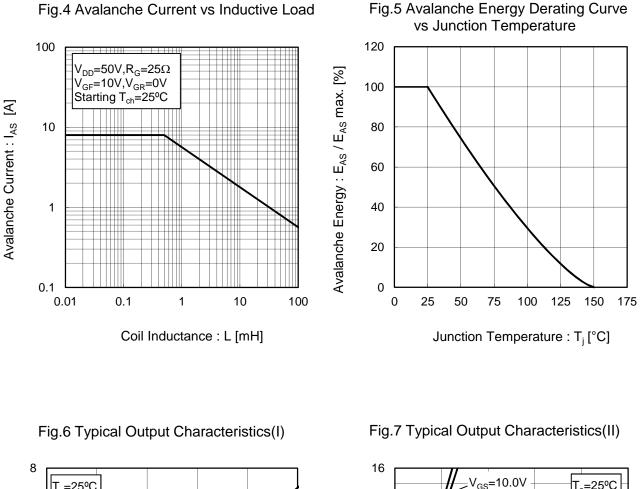
Fig.2 Maximum Safe Operating Area

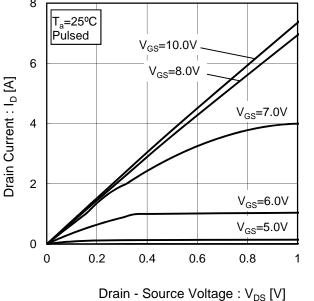


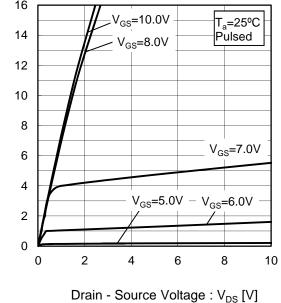
Drain - Source Voltage : V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

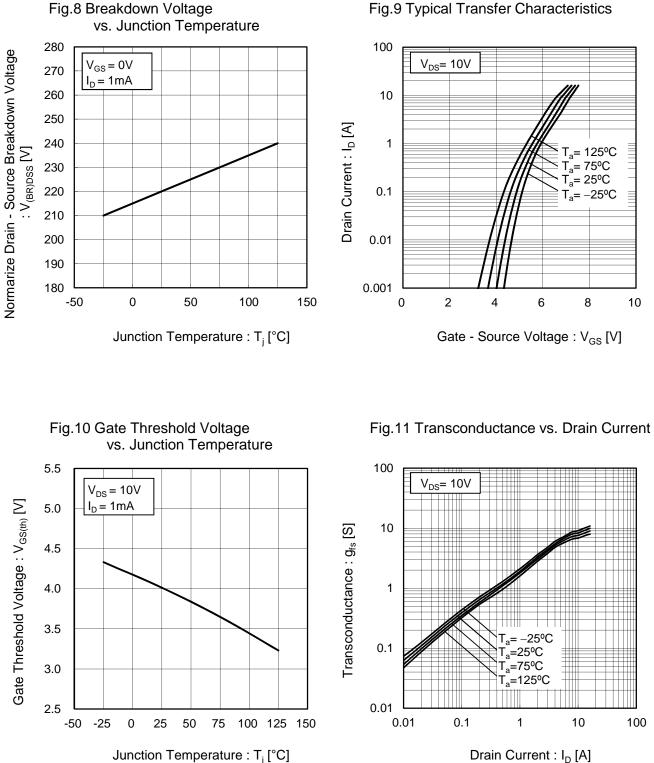








Drain Current : I_D [A]



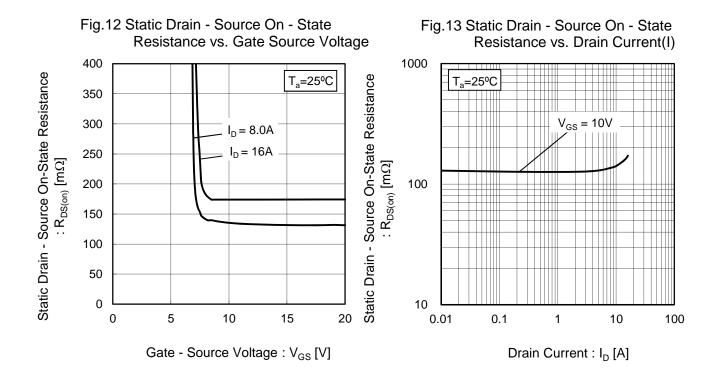
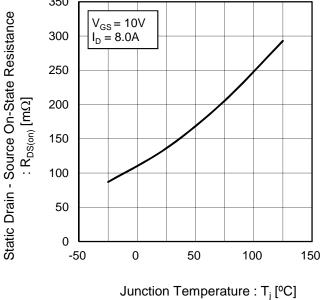
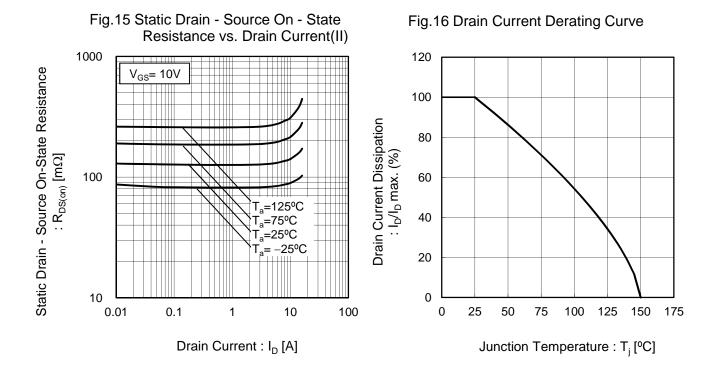


Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature





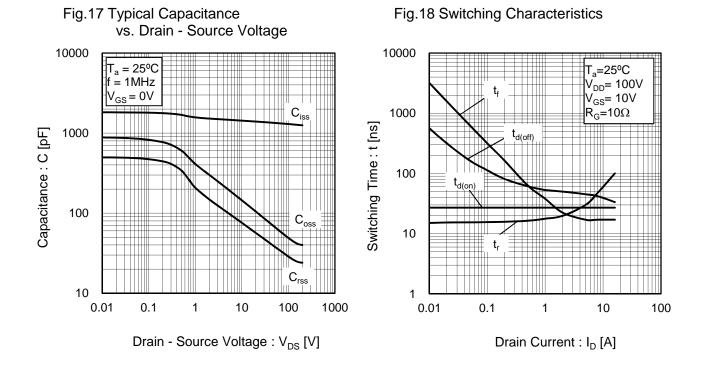
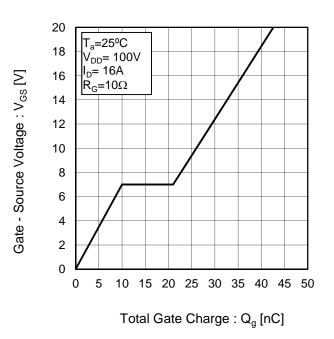
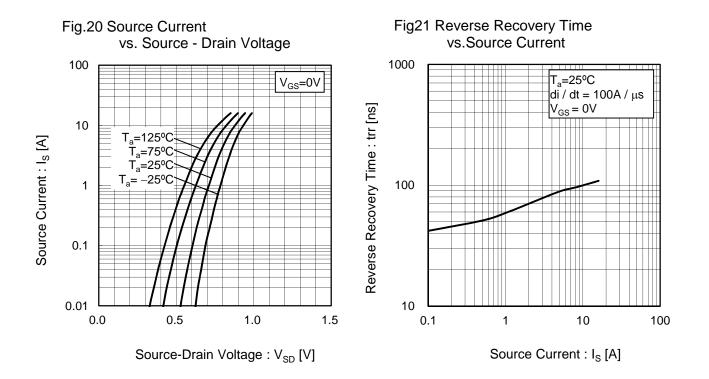


Fig.19 Dynamic Input Characteristics





Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

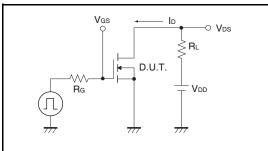


Fig.2-1 Gate Charge Measurement Circuit

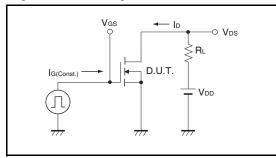


Fig.3-1 Avalanche Measurement Circuit

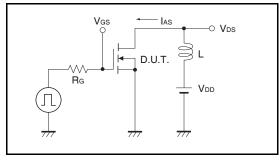


Fig.1-2 Switching Waveforms

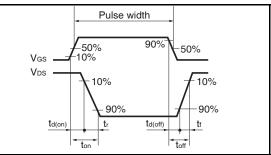


Fig.2-2 Gate Charge Waveform

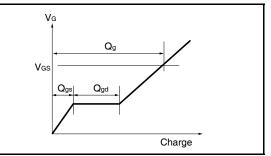
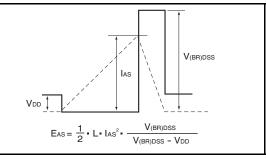
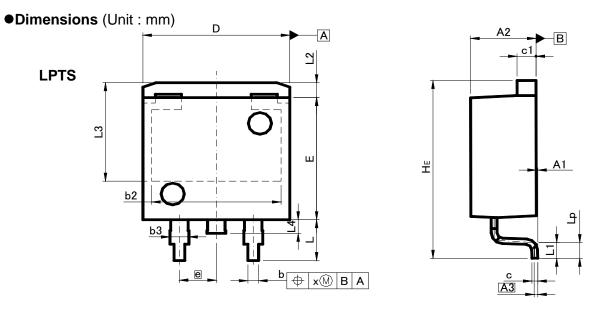
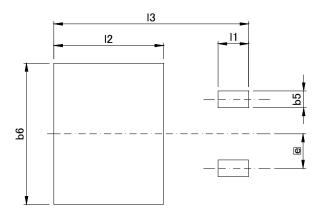


Fig.3-2 Avalanche Waveform







Patterm of terminal position areas

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A1	0.00	0.30	0	0.012
A2	4.30	4.70	0.169	0.185
A3	0.1	25	0.	01
b	0.68	0.98	0.027	0.039
b2	8.	90	0.	35
b3	1.14	1.44	0.045	0.057
с	0.30	0.60	0.012	0.024
c1	1.10	1.50	0.043	0.059
D	9.80	10.40	0.386	0.409
E	8.80	9.20	0.346	0.362
е	2.	54	0.10	
HE	12.80	13.40	0.504	0.528
L	2.70	3.30	0.106	0.13
L1	0.90	1.50	0.035	0.059
L2	1.10		0.0)43
L3	7.25		0.2	85
L4	1.00		0.0)39
Lp	0.90	1.50	0.035	0.059
х	-	0.25	-	0.01

DIM	MILIM	ETERS	INCHES		
DIN	MIN	MAX	MIN	MAX	
b5	-	1.23	-	0.049	
b6	-	10.40	-	0.409	
1	-	2.10	-	0.083	
12	-	7.55	-	0.297	
13	-	13.40	-	0.528	

Dimension in mm/inches

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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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